

FMH28N50E

FUJI POWER MOSFET

Super FAP-E³ series

N-CHANNEL SILICON POWER MOSFET

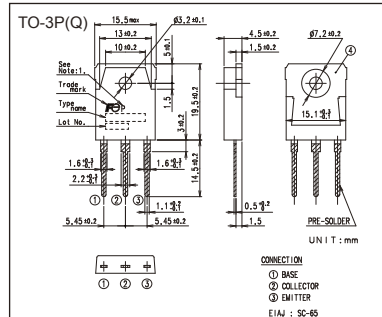
■ Features

- Maintains both low power loss and low noise
- Lower R_{DS(on)} characteristic
- More controllable switching dv/dt by gate resistance
- Smaller V_{GS} ringing waveform during switching
- Narrow band of the gate threshold voltage (3.0±0.5V)
- High avalanche durability

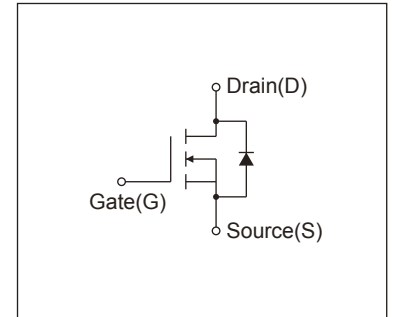
■ Applications

- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters

■ Outline Drawings [mm]



■ Equivalent circuit schematic



■ Maximum Ratings and Characteristics

● Absolute Maximum Ratings at T_c=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain-Source Voltage	V _{DS}	500	V	
	V _{DSSX}	500	V	V _{GS} = -30V
Continuous Drain Current	I _D	±28	A	
Pulsed Drain Current	I _{DP}	±112	A	
Gate-Source Voltage	V _{GS}	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	I _{AR}	28	A	Note*1
Non-Repetitive Maximum Avalanche Energy	E _{AS}	1033.1	mJ	Note*2
Repetitive Maximum Avalanche Energy	E _{AR}	40	mJ	Note*3
Peak Diode Recovery dv/dt	dv/dt	10.9	kV/μs	Note*4
Peak Diode Recovery -di/dt	-di/dt	100	A/μs	Note*5
Maximum Power Dissipation	P _D	2.50	W	T _a =25°C
		400		T _c =25°C
Operating and Storage Temperature range	T _{ch}	150	°C	
	T _{stg}	-55 to + 150	°C	

● Electrical Characteristics at T_c=25°C (unless otherwise specified)

Description	Symbol	Conditions	min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA, V _{GS} =0V	500	-	-	V
Gate Threshold Voltage	V _{GS} (th)	I _D =250μA, V _{DS} =V _{GS}	2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =500V, V _{GS} =0V	-	-	25	μA
		V _{DS} =400V, V _{GS} =0V	-	-	250	
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V	-	10	100	nA
Drain-Source On-State Resistance	R _{DS} (on)	I _D =14A, V _{GS} =10V	-	0.16	0.19	Ω
Forward Transconductance	g _{fs}	I _D =14A, V _{DS} =25V	16	32	-	S
Input Capacitance	C _{iss}	V _{DS} =25V	-	4400	6600	pF
Output Capacitance	C _{oss}	V _{GS} =0V	-	420	630	
Reverse Transfer Capacitance	C _{rss}	f=1MHz	-	32	48	
Turn-On Time	td(on)	V _{CC} =300V	-	26	39	ns
	tr	V _{GS} =10V	-	14	21	
Turn-Off Time	td(off)	I _D =14A	-	144	216	
	tf	R _{GS} =5.1Ω	-	24	36	
Total Gate Charge	Q _G	V _{CC} =250V	-	130	195	nC
Gate-Source Charge	Q _{GS}	I _D =28A	-	30	45	
Gate-Drain Charge	Q _{GD}	V _{GS} =10V	-	40	60	
Avalanche Capability	I _{AV}	L=1.04mH, T _{ch} =25°C	28	-	-	A
Diode Forward On-Voltage	V _{SD}	I _F =28A, V _{GS} =0V, T _{ch} =25°C	-	0.90	1.35	V
Reverse Recovery Time	trr	I _F =28A, V _{GS} =0V	-	0.72	-	μs
Reverse Recovery Charge	Q _{rr}	-di/dt=100A/μs, T _{ch} =25°C	-	11.2	-	μC

● Thermal Characteristics

Description	Symbol	Test Conditions	min.	typ.	max.	Unit
Thermal resistance	R _{th} (ch-c)	Channel to Case			0.313	°C/W
	R _{th} (ch-a)	Channel to Ambient			50.0	°C/W

Note *1 : T_{ch}≤150°C

Note *2 : Stating T_{ch}=25°C, I_{AS}=12A, L=13.2mH, V_{CC}=50V, R_G=50Ω
E_{AS} limited by maximum channel temperature and avalanche current.
See to 'Avalanche Energy' graph.

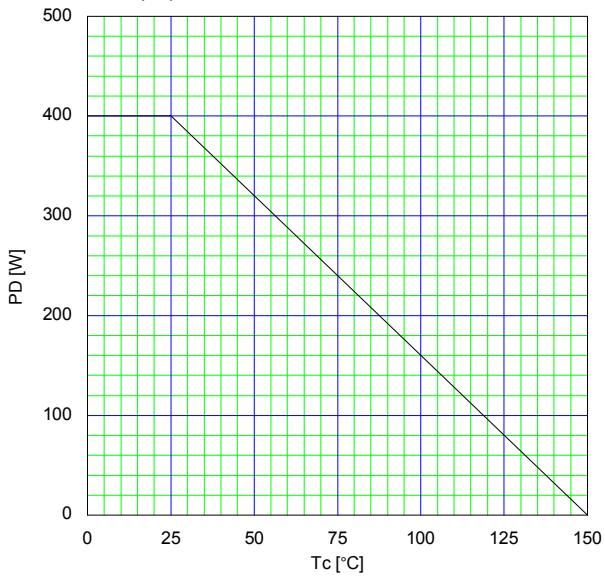
Note *3 : Repetitive rating : Pulse width limited by maximum channel temperature.

See to the 'Transient Thermal Impedance' graph.

Note *4 : I_F≤I_D, -di/dt=100A/μs, V_{CC}≤BV_{DSS}, T_{ch}≤150°C.

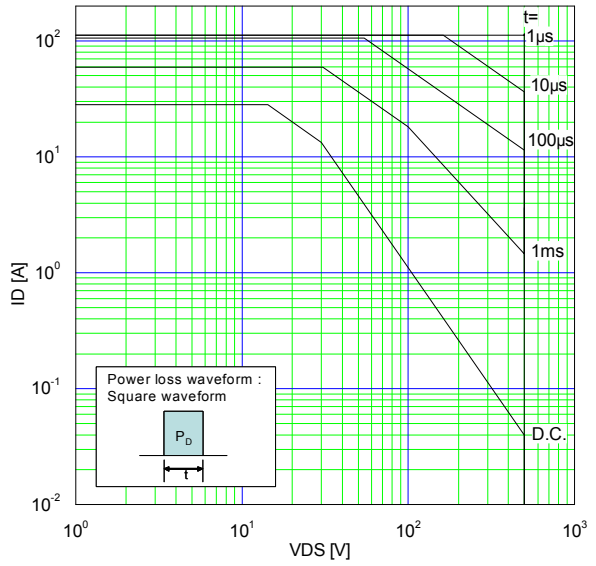
Note *5 : I_F≤I_D, dv/dt=10.9kV/μs, V_{CC}≤BV_{DSS}, T_{ch}≤150°C.

Allowable Power Dissipation
 $PD=f(T_c)$

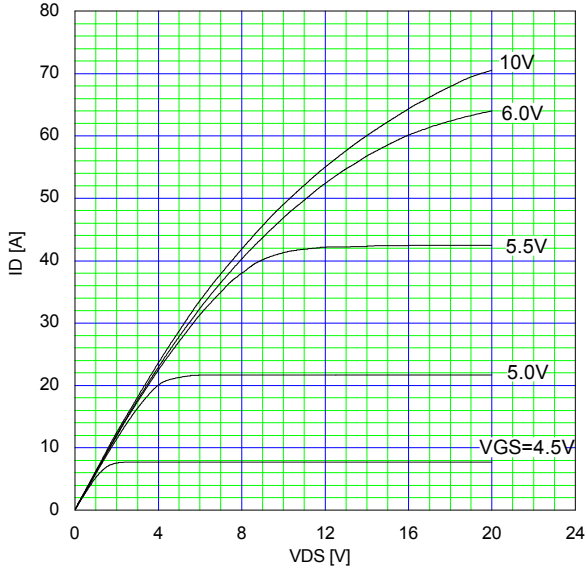


Safe Operating Area

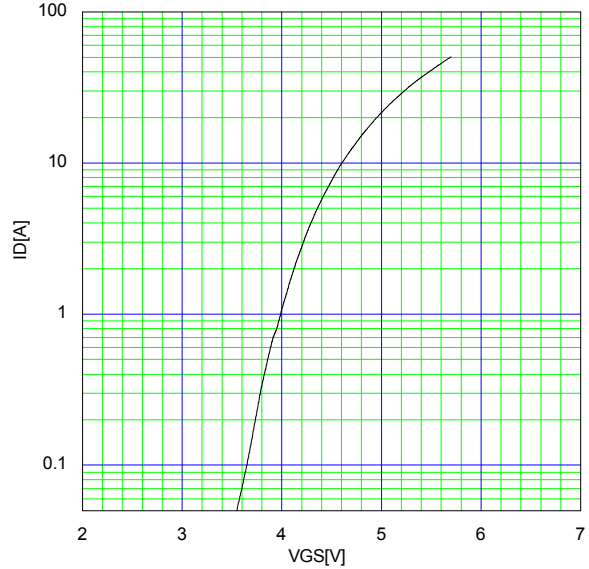
$I_D=f(V_{DS}):Duty=0(\text{Single pulse}),T_c=25^{\circ}C$



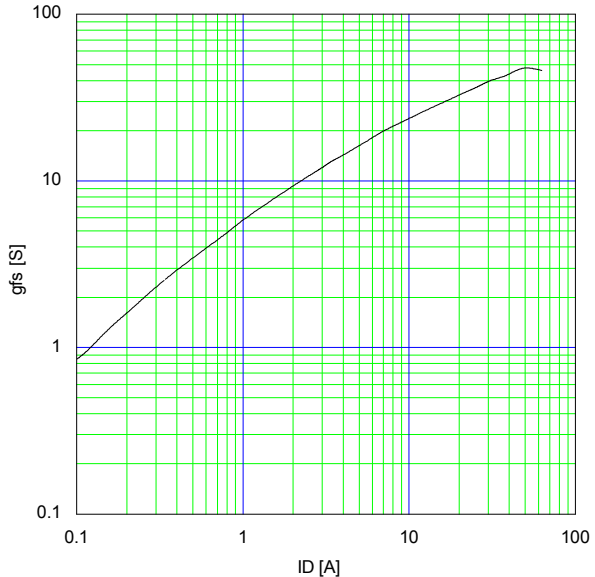
Typical Output Characteristics
 $I_D=f(V_{DS}):80 \mu s \text{ pulse test}, T_{ch}=25^{\circ}C$



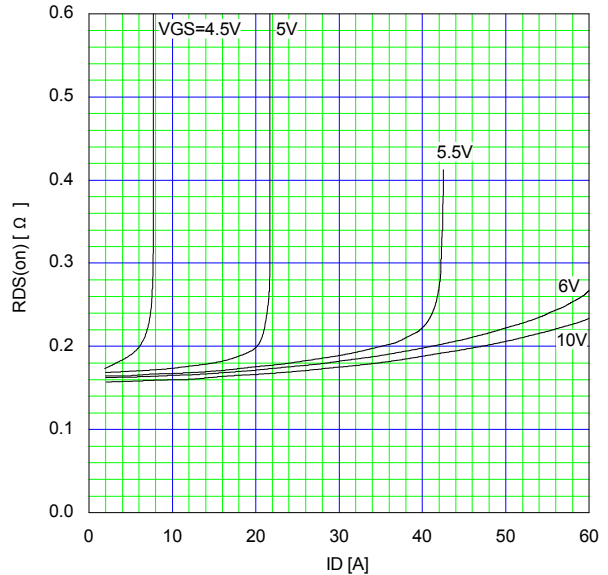
Typical Transfer Characteristic
 $I_D=f(V_{GS}):80 \mu s \text{ pulse test}, V_{DS}=25V, T_{ch}=25^{\circ}C$



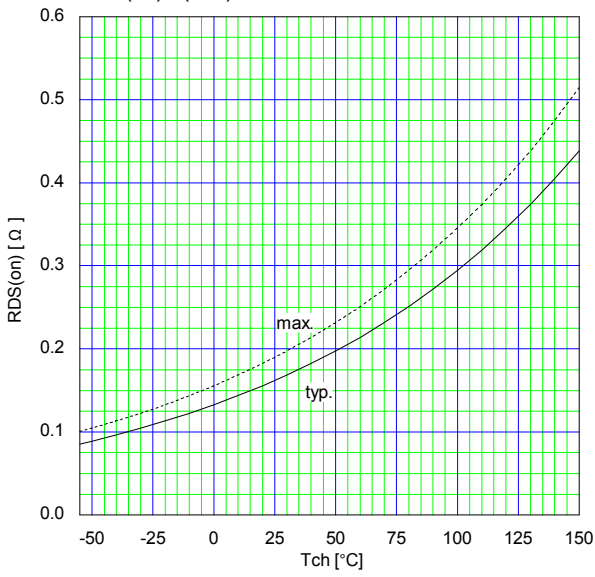
Typical Transconductance
 $g_{fs}=f(I_D):80 \mu s \text{ pulse test}, V_{DS}=25V, T_{ch}=25^{\circ}C$



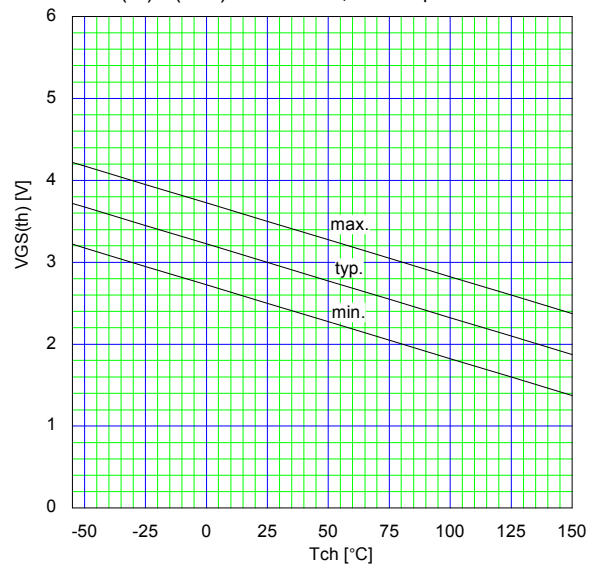
Typical Drain-Source on-state Resistance
 $R_{DS(on)}=f(I_D):80 \mu s \text{ pulse test}, T_{ch}=25^{\circ}C$



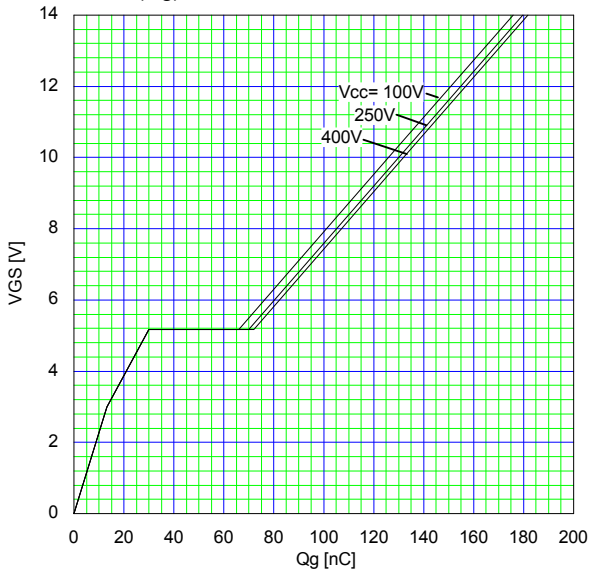
Drain-Source On-state Resistance
 $R_{DS(on)} = f(T_{ch}): I_D = 14A, V_{GS} = 10V$



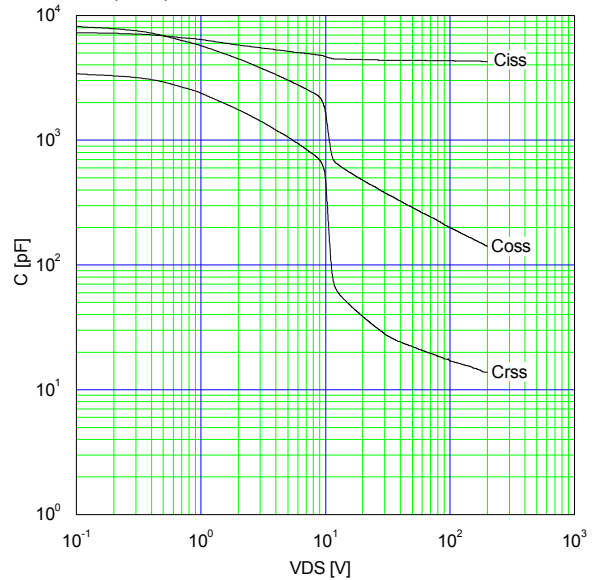
Gate Threshold Voltage vs. T_{ch}
 $V_{GS(th)} = f(T_{ch}): V_{DS} = V_{GS}, I_D = 250\mu A$



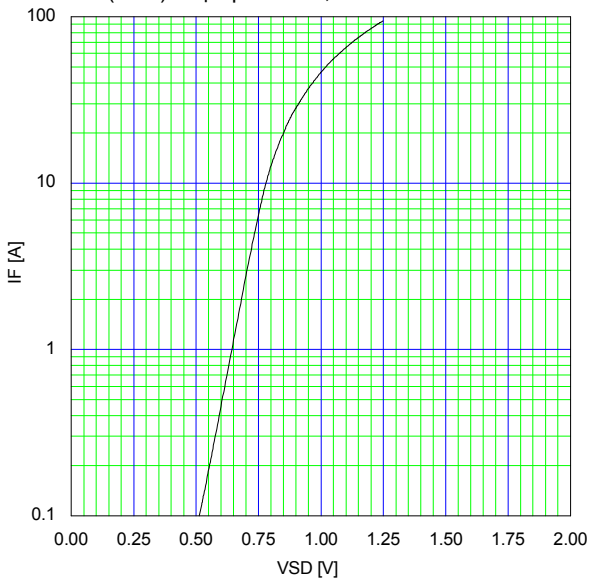
Typical Gate Charge Characteristics
 $V_{GS} = f(Q_g): I_D = 28A, T_{ch} = 25\text{ °C}$



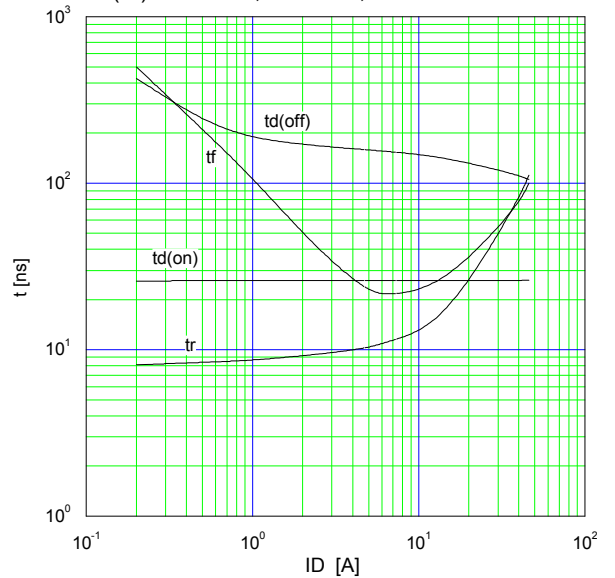
Typical Capacitance
 $C = f(V_{DS}): V_{GS} = 0V, f = 1MHz$

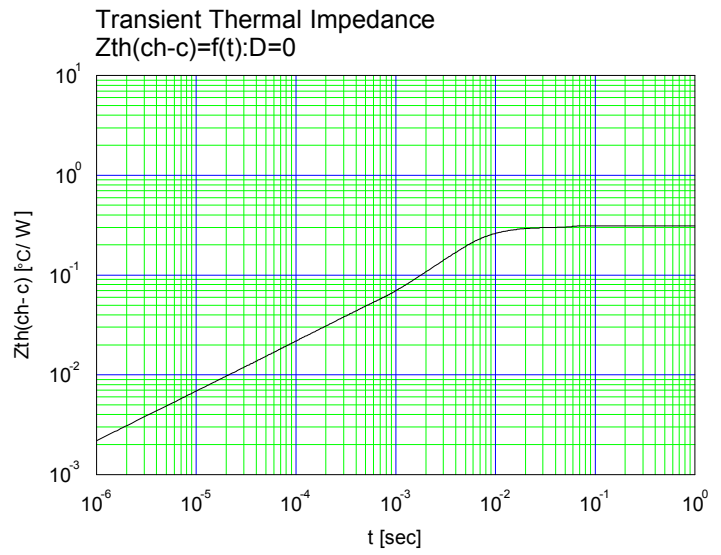
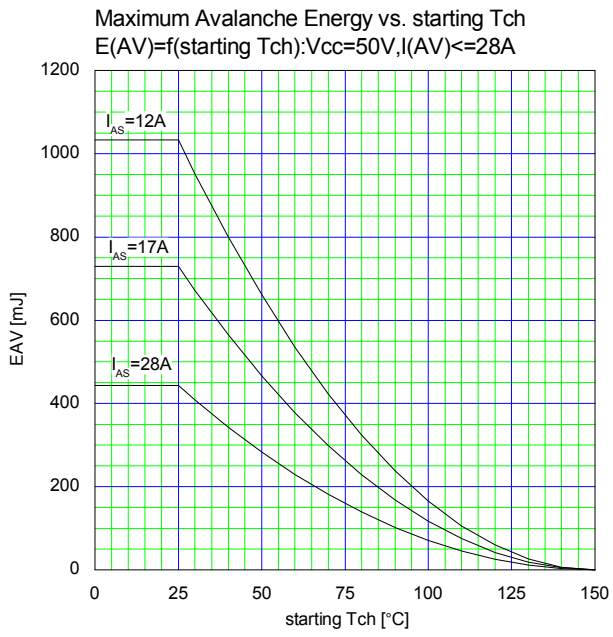


Typical Forward Characteristics of Reverse Diode
 $I_F = f(V_{SD}): 80\ \mu s\ pulse\ test, T_{ch} = 25\text{ °C}$



Typical Switching Characteristics vs. ID
 $t = f(I_D): V_{cc} = 300V, V_{GS} = 10V, R_G = 5.1\ \Omega$





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